MLF / MLFM Series Metal Film Melf Resistor

Stackpole Electronics, Inc.

Resistive Product Solutions

Features:

- Thin film technology for precision and stability
- Excellent power to size ratio
- Exhibits good pulse power characteristics
- Part is inherently anti-sulfur
- 100% RoHS compliant and lead free without exemption
- Halogen free
- REACH compliant



Electrical Specifications											
Type/Code	Package Size	Power Rating (W)	(W) Working Overload			orking Overload TCR (ppm/		Ohmic Range (Ω		e) and Tolerance	
	0.20	@ 70ºC	Voltage (V) ⁽¹⁾	Voltage (V)		0.1%	0.5%	1%	5%		
MLF18	0102	0.125	150	300	± 15		100 - 56K		-		
IVILF 10	0102	0.125	150	300	± 25	100 - 82K	49.9 - 200K	49.9 - 390K	-		
					± 50	-		1 - 1M			
					± 100		-	1 -	1M		
		Jumper: 2A			-		0 Ω (<	15mΩ)			
MLFM15	0102	0.0	200	400	± 15		100 - 56K		-		
MLFM15	0102	0.2	200	400	± 25	100 - 82K	49.9 - 200K	49.9 - 390K	-		
					± 50	-		1 - 1M			
		0.3			± 100	-	-	1 -	1M		
					± 5	10 - 332K		-			
					± 10		10 - 20K				
		0.05			± 15	10 - 300K					
MLF14	0204	0.25	200	400	± 25	10 - 1M		1 - 4.7M			
					± 50	10 - 1M	1 - 1M	0.2 -	10M		
					± 100	-	-	0.1 -	10M		
		Jumper: 2 A			-	0 Ω (< 15mΩ)					
					± 5	10 - 332K		_			
	0204			400	± 15	10 - 100K					
MLFM25		0.4	200		± 25	10 - 1M		1 - 3.4M			
					± 50	10 - 1M	1 - 1M	0.2	- 1M		
					± 100		-	0.1	- 1M		
		Ì			± 5	10 - 332K		-			
					± 10		10 -	20K			
					± 15		10 - 3	300K			
MLF12	0207	0.5	300	600	± 25	10 -	- 1M	1 - 4	1.7M		
					± 50	10 - 1M	1 - 1M	0.2 -	10M		
					± 100		_	0.1 -	10M		
		Jumper: 4 A			-		0 Ω (<				
					± 5	10 - 332K	, , , , , , , , , , , , , , , , , , ,	-			
					± 15	10 - 100K	•				
MLFM1	0207	1	350	700	± 25		· 1M	1 - 3	8.4M		
					± 50	10 - 1M	1 - 1M	0.2 -			
					± 100		-	0.1 -	10M		

Note: (1) Lesser of $\sqrt{P^*R}$ or maximum working voltage

Resistive Product Solutions

				N	lechanical Spe	cifications				
					L D					
	Weight (g) L (1000 pieces) Body Ler			L1 (min.) ngth Inner Body Length		D Body Diameter	D1 Middle Body Dia	K I. Termination	Unit	
MLF18		7.7	0.087 ± 0.0 2.20 ± 0.1	004	0.043 1.10	0.043 ± 0.004 1.10 ± 0.10	0.043 +0/-0.00	6 0.018 ± 0.00		
MLFM15	7	7.7	0.087 ± 0. 2.20 ± 0.		0.043 1.10	0.043 ± 0.004 1.10 ± 0.10	0.043 +0/-0.00 1.10 +0/-0.15			
MLF14	1	8.7	0.138 ± 0. 3.50 ± 0.2		0.067 1.70	0.055 ± 0.006 1.40 ± 0.15	0.055 +0/-0.00 1.40 +0/-0.20	0.80 ± 0.10	mm	
MLFM25	1	8.7	0.138 ± 0. 3.50 ± 0.1		0.059 1.50	0.055 ± 0.006 1.40 ± 0.15	0.055 +0/-0.00 1.40 +0/-0.20			
MLF12	8	0.9	0.232 ± 0.000 5.90 ± 0.0000		0.114 2.90	0.087 ± 0.008 2.20 ± 0.20	0.087 +0/-0.00 2.20 +0/-0.20	1.30 ± 0.10	mm	
MLFM1	8	0.9	0.232 ± 0.000 5.90 ± 0.0000		0.114 2.90	0.087 ± 0.008 2.20 ± 0.20	0.087 +0/-0.00 2.20 +0/-0.20			
		·			erformance Cha				·	
Test		Test Method			Test Condition			Test Specification 5% and below Jump		
Temperature Coefficient of Resistance (T.C.R.)		JIS-C-5201-1 4.8 IEC-60115-1 4.8		At 25°C/-55°C and 25°C/+125°C, 25°C is the reference temperature. 5ppm: At 25°C/-10°C and 25°C/+85°C, 25°C is the reference temperature				As specified		
Short Time Overload	1	JIS-C-5201-1 4.13 IEC-60115-1 4.13		RCWV*2.5 or max. overload voltage whichever is lower for 5 seconds		0102: ± (0	0204/0207: ± (0.15% + 0.05Ω) 0102: ± (0.15% + 0.01Ω) 5ppm: ± (0.05% + 0.01Ω)			
Insulation Resistance	9	JIS-C-5201-1 4.6 IEC-60115-1 4.6		Max. overload voltage for 1 minute				≥10G		
Endurance		JIS-C-5201-1 4.25 IEC-60115-1 4.25.1		$70 \pm 2^{\circ}$ C, RCWV for 1000 hours with 1.5 hour "ON" and 0.5 hour "OFF"		0102: ± (0204/0207: ± (0.15% + 0.05Ω) 0102: ± (0.5% + 0.05Ω) 5ppm: ± (0.25% + 0.01Ω)			
Damp Heat with Load	d	JIS-C-5201-1 4.24 IEC-60115-1 4.24		40 ± 2°C, 90 ~ 95% R.H., RCWV for 1000 hours with 1.5 hour "ON" and 0.5 hour "OFF"			0204/0207: ± (1% + 0.05Ω) 5ppm: ± (0.25% + 0.01Ω)			
Dry Heat		JIS-C-5201-1 4.23 IEC-60115-1 4.23.2		At +125°C / +155°C for 1000 hours		0102: ±	0204/0207: ± (1% + 0.05Ω) 0102: ± (1% + 0.05Ω) 5ppm: ± (0.25% + 0.01Ω)			
Bending Strength			201-1 4.33 115-1 4.33	Bending once for 5 seconds with 2 mm		± (0.5	± (0.5% + 0.05Ω) 5ppm: ± (0.1% + 0.01Ω)			
Solderability		JIS-C-5	201-1 4.17 115-1 4.17		245 ± 5°C for 3 seconds			95% min. coverage		
Resistance to Soldering Heat		JIS-C-5	201-1 4.18 115-1 4.18		260 ± 5°C for 10 seconds			% + 0.05Ω) 0.05% + 0.01Ω)	< 15mΩ	
Voltage Proof		JIS-C-5	5201-1 4.7 0115-1 4.7	1.42	times max. operatino	g voltage for 1 minute		eakdown or flasho	ver	
Leaching		JIS-C-5 EC-6006	201-1 4.18 8-2-58 8.2.1	260 ± 5°C for 30 seconds		To	Individual leacing area ≤ 5% Total Leaching area ≤ 10%			
Rapid Change of Temperature			201-1 4.19 115-1 4.19		-55°C to +125°C / +	155°C, 5 cycles		% + 0.05Ω) (0.2% + 0.01Ω)	< 15mΩ	

RCWV (rated continuous working voltage) = $v(P^*R)$ or max. operating voltage whichever is lower.

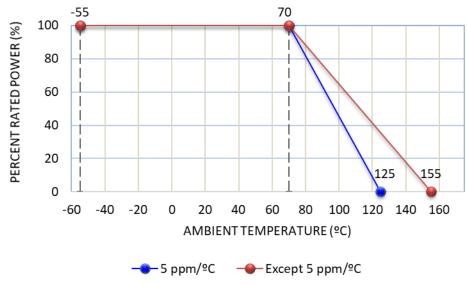
Storage temperature: $25^{\circ}C \pm 3^{\circ}C$, humidity < 80% R.H.

Operating temperature range is -55° C to $+155^{\circ}$ C except for 5 ppm/°C. Operating temperature range for 5 ppm/°C is -55° C to $+125^{\circ}$ C.

Rev Date: 8/17/2023

Resistive Product Solutions

Power Derating Curve:



Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

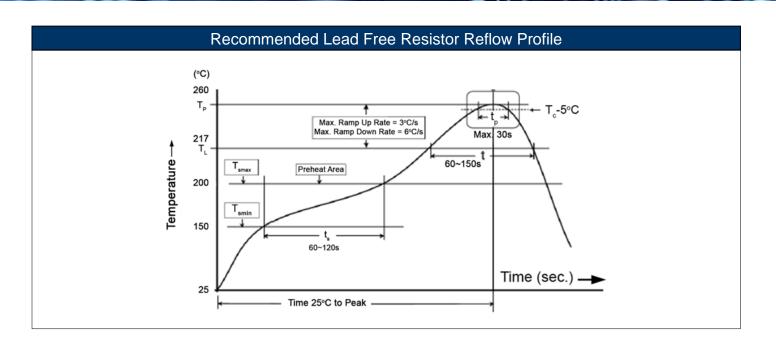
Wave Soldering						
Description	Maximum	Recommended	Minimum			
Preheat Time	80 seconds	70 seconds	60 seconds			
Temperature Diff.	140°C	120°C	100°C			
Solder Temp.	260°C	250°C	240°C			
Dwell Time at Max.	10 seconds	5 seconds	*			
Ramp DN (°C/sec)	N/A	N/A	N/A			

Temperature Diff. = Defference between final preheat stage and soldering stage.

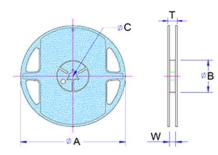
Convection IR Reflow						
Description	Maximum	Recommended	Minimum			
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*			
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds			
Solder Temp.	260°C	245°C	*			
Dwell Time at Max.	30 seconds	15 seconds	10 seconds			
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*			

Metal Film Melf Resistor

MLF / MLFM Series



Reel Specifications

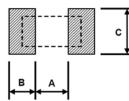


Type/Code	øA	øB	øC	W	Т	Unit
MLF18	7.028 ± 0.059	2.362 ± 0.039	0.512 ± 0.008	0.354 ± 0.020	0.492 ± 0.020	inches
IVILF 18	178.50 ± 1.50	60.00 ± 1.00	13.00 ± 0.20	9.00 ± 0.50	12.50 ± 0.50	mm
MLFM15	7.028 ± 0.059	2.362 ± 0.039	0.512 ± 0.008	0.354 ± 0.020	0.492 ± 0.020	inches
	178.50 ± 1.50	60.00 ± 1.00	13.00 ± 0.20	9.00 ± 0.50	12.50 ± 0.50	mm
MLF14	7.028 ± 0.059	2.362 ± 0.039	0.512 ± 0.008	0.354 ± 0.020	0.492 ± 0.020	inches
	178.50 ± 1.50	60.00 ± 1.00	13.00 ± 0.20	9.00 ± 0.50	12.50 ± 0.50	mm
MLFM25	7.028 ± 0.059	2.362 ± 0.039	0.512 ± 0.008	0.354 ± 0.020	0.492 ± 0.020	inches
IVILFIVI25	178.50 ± 1.50	60.00 ± 1.00	13.00 ± 0.20	9.00 ± 0.50	12.50 ± 0.50	mm
MLF12	7.028 ± 0.059	2.362 ± 0.039	0.512 ± 0.020	0.512 ± 0.020	0.610 ± 0.020	inches
IVILF 12	178.50 ± 1.50	60.00 ± 1.00	13.00 ± 0.50	13.00 ± 0.50	15.50 ± 0.50	mm
MLFM1	7.028 ± 0.059	2.362 ± 0.039	0.512 ± 0.020	0.512 ± 0.020	0.610 ± 0.020	inches
	178.50 ± 1.50	60.00 ± 1.00	13.00 ± 0.50	13.00 ± 0.50	15.50 ± 0.50	mm

Resistive Product Solutions

	Packaging Specifications - Embossed Plastic Tape								
Top Tape ϕ^{D_0} F F W ϕ^{D_1} F ϕ^{D_1} F F ϕ^{D_1} ϕ^{D_1} F F F ϕ^{D_1} F F F ϕ^{D_1} F F F F ϕ^{D_1} F F F F ϕ^{D_1} F F F ϕ^{D_1} F F F F ϕ^{D_1} F F F F ϕ^{D_1} F F F F F F ϕ^{D_1} F F F F F F ϕ^{D_1} F F F F F F F F									
Type/Code	A	В	W	E	F	P0	Unit		
MLF18	0.051 ± 0.004 1.30 ± 0.10	0.094 ± 0.004 2.40 ± 0.10	0.315 ± 0.004 8.00 ± 0.10	0.069 ± 0.004 1.75 ± 0.10	0.138 ± 0.002 3.50 ± 0.05	0.157 ± 0.004 4.00 ± 0.10	inches mm		
MLFM15	0.051 ± 0.004 1.30 ± 0.10	0.094 ± 0.004 2.40 ± 0.10	0.315 ± 0.004 8.00 ± 0.10	0.069 ± 0.004 1.75 ± 0.10	0.138 ± 0.002 3.50 ± 0.05	0.157 ± 0.004 4.00 ± 0.10	inches mm		
MLF14	0.061 ± 0.004 1.55 ± 0.10	0.144 ± 0.004 3.65 ± 0.10	0.315 ± 0.004 8.00 ± 0.10	0.069 ± 0.004 1.75 ± 0.10	0.138 ± 0.002 3.50 ± 0.05	0.157 ± 0.004 4.00 ± 0.10	inches mm		
MLFM25	0.061 ± 0.004 1.55 ± 0.10	0.144 ± 0.004 3.65 ± 0.10	0.315 ± 0.004 8.00 ± 0.10	0.069 ± 0.004 1.75 ± 0.10	0.138 ± 0.002 3.50 ± 0.05	0.157 ± 0.004 4.00 ± 0.10	inches mm		
MLF12	0.094 ± 0.004 2.40 ± 0.10	0.242 ± 0.004 6.15 ± 0.10	0.472 ± 0.004 12.00 ± 0.10	0.069 ± 0.004 1.75 ± 0.10	0.217 ± 0.002 5.50 ± 0.05	$\begin{array}{r} 0.157 \pm 0.004 \\ 4.00 \pm 0.10 \end{array}$	inches mm		
MLFM1	$\begin{array}{r} 2.10 \pm 0.100 \\ 0.094 \pm 0.004 \\ 2.40 \pm 0.10 \end{array}$	0.242 ± 0.004 6.15 ± 0.10	0.472 ± 0.004 12.00 ± 0.10	0.069 ± 0.004 1.75 ± 0.10	0.217 ± 0.002 5.50 ± 0.05	$\begin{array}{r} 0.157 \pm 0.004 \\ 4.00 \pm 0.10 \end{array}$	inches mm		
Type/Code	P1	P2	D0	D1	Т	Unit			
MLF18	0.157 ± 0.004 4.00 ± 0.10	0.079 ± 0.002 2.00 ± 0.05	0.059 ± 0.004 1.50 ± 0.10	0.035 min. 0.90 min.	0.059 ± 0.004 1.50 ± 0.10	inches mm			
MLFM15	0.157 ± 0.004 4.00 ± 0.10	0.079 ± 0.002 2.00 ± 0.05	0.059 ± 0.004 1.50 ± 0.10	0.035 min. 0.90 min.	0.059 ± 0.004 1.50 ± 0.10	inches mm			
MLF14	0.157 ± 0.004 4.00 ± 0.10	0.079 ± 0.002 2.00 ± 0.05	0.059 ± 0.004 1.50 ± 0.10	0.035 min. 0.90 min.	0.071 ± 0.004 1.80 ± 0.10	inches mm			
MLFM25	0.157 ± 0.004 4.00 ± 0.10	0.079 ± 0.002 2.00 ± 0.05	0.059 ± 0.004 1.50 ± 0.10	0.035 min. 0.90 min.	0.071 ± 0.004 1.80 ± 0.10	inches mm			
MLF12	0.157 ± 0.004 4.00 ± 0.10	0.079 ± 0.002 2.00 ± 0.05	0.059 ± 0.004 1.50 ± 0.10	0.055 min. 1.40 min.	0.106 ± 0.004 2.70 ± 0.10	inches mm			
MLFM1	0.157 ± 0.004 4.00 ± 0.10	0.079 ± 0.002 2.00 ± 0.05	0.059 ± 0.004 1.50 ± 0.10	0.055 min. 1.40 min.	0.106 ± 0.004 2.70 ± 0.10	inches mm			

Recommended Pad Layout



Type/Code	A	В	С	Unit
MLF18	0.039	0.031	0.059	inches
MEE 18	1.00	0.80	1.50	mm
MLFM15	0.039	0.031	0.059	inches
	1.00	0.80	1.50	mm
MLF14	0.063	0.047	0.063	inches
	1.60	1.20	1.60	mm
MLFM25	0.063	0.047	0.063	inches
IVILFIVI25	1.60	1.20	1.60	mm

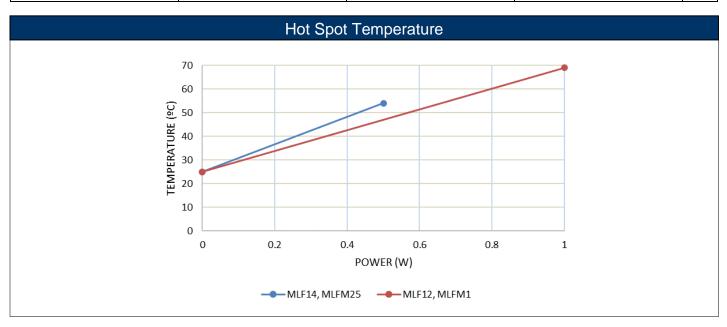
MLF / MLFM Series

Stackpole Electronics, Inc.

Metal Film Melf Resistor

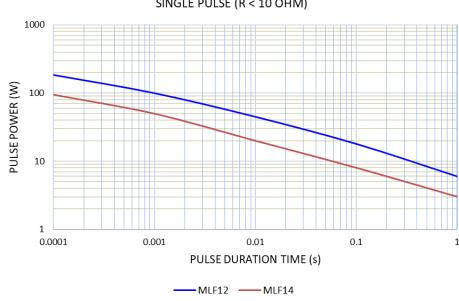
Resistive Product Solutions

Recommended Pad Layout (cont.)								
Type/Code	A	В	С	Unit				
MLF12	0.118	0.067	0.094	inches				
	3.00	1.70	2.40	mm				
MLFM1	0.118	0.067	0.094	inches				
	3.00	1.70	2.40	mm				



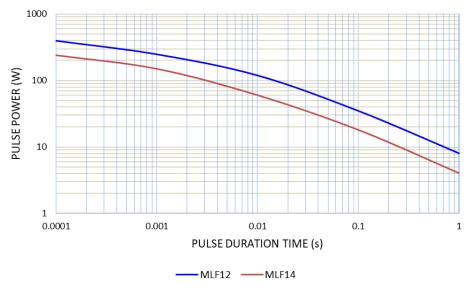
Pulse withstanding capacity

The single impulse graph is the result of 50 impulses of rectangular shape applied at one-minute intervals. The limit of acceptance was a shift in resistance of less than 1% from the initial value. The power applied was subject to the restrictions of the maximum permissible impulse voltage graph shown.

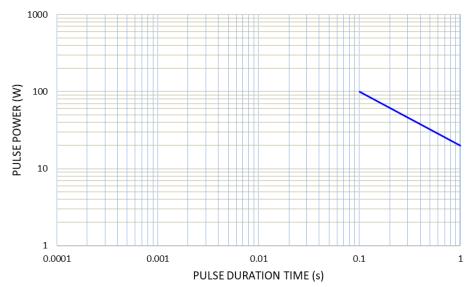


SINGLE PULSE (R < 10 OHM)

SINGLE PULSE ($R \ge 10 \text{ OHM}$)

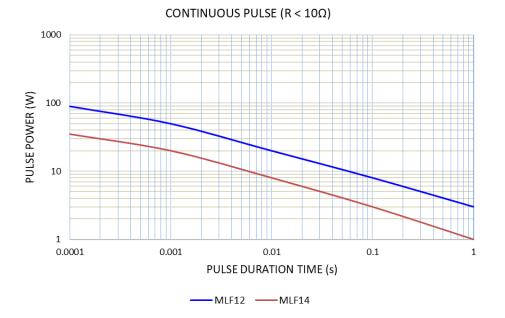


MLFM1 SINGLE PULSE (1Kohms)

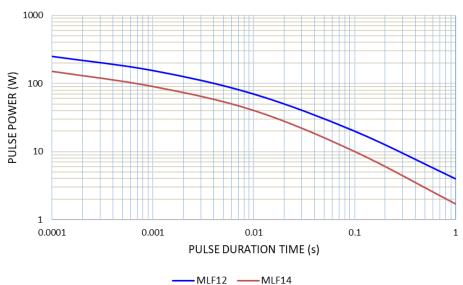


Continuous Pulse

The continuous load graph was obtained by applying repetitive rectangular pulses where the pulse period was adjusted so that the average power dissipated in the resistor was equal to its rated power at 70°C. Again the limit of acceptance was a shift in resistance of less than 1% from the initial value.



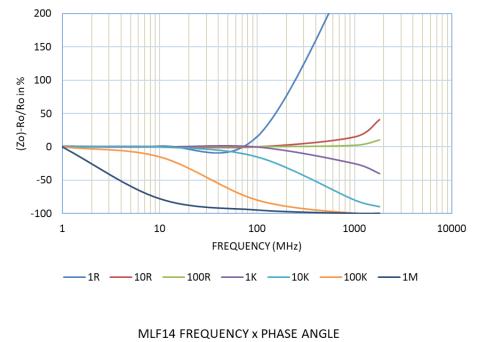
CONTINUOUS PULSE ($R \ge 10\Omega$)



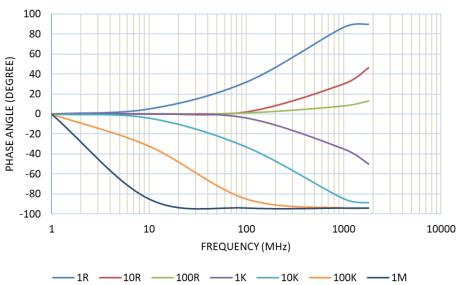
Frequency behavior

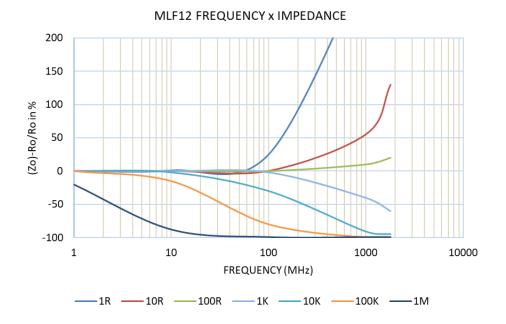
Resistors are designed to function according to Ohmic laws. This is basically true of resistors for frequencies up to 100 kHz. At higher frequencies, there is an additional contribution to the impedance by an ideal resistor switched in series with a coil and both switched parallel to a capacitor. The values of the capacitance and inductance are mainly determined by the dimensions of the terminations and the conductive path length.

The environment surrounding components has a large influence on the behavior of the component on the printed-circuit board.



MLF14 FREQUENCY x IMPEDANCE

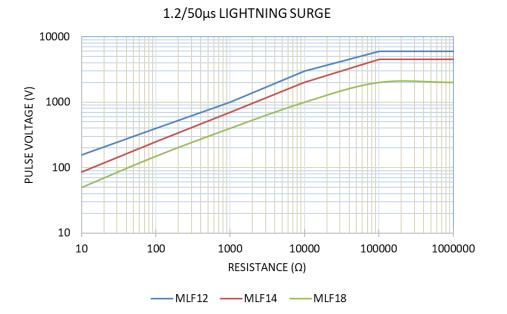




MLF12 FREQUENCY x PHASE ANGLE 100 80 60 PHASE ANGLE (DEGREE) 40 20 0 -20 -40 -60 -80 -100 1 10 100 1000 10000 FREQUENCY (MHz)

Lightning Surge

Resistors are tested in accordance with IEC 60 115-1 using both 1.2/50us and 10/700us pulse shapes. The limit of acceptance is a shift in resistance of less than 0.5% from the initial value.



10/700μs LIGHTNING SURGE

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

	RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)			
MLF	Precision Metal Film Melf Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always			
MLFM	Precision Metal Film Mini Melf Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always			

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

